

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT						
NATURE OF CONVEYANCE:	ASSIGNMENT						
CONVEYING PARTY DATA							
<table border="1" style="width:100%; border-collapse: collapse;"> <thead> <tr> <th style="width:70%;">Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Pingshan Wang</td> <td>09/03/2008</td> </tr> <tr> <td>Chunrong Song</td> <td>09/03/2008</td> </tr> </tbody> </table>		Name	Execution Date	Pingshan Wang	09/03/2008	Chunrong Song	09/03/2008
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Pingshan Wang	09/03/2008						
Chunrong Song	09/03/2008						
RECEIVING PARTY DATA							
Name:	Clemson University						
Street Address:	91 Technology Drive, Room 222						
City:	Anderson						
State/Country:	SOUTH CAROLINA						
Postal Code:	29625						
PROPERTY NUMBERS Total: 1							
<table border="1" style="width:100%; border-collapse: collapse;"> <thead> <tr> <th style="width:30%;">Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>12179047</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	12179047		
Property Type	Number						
Application Number:	12179047						
CORRESPONDENCE DATA							
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<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>							
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ATTORNEY DOCKET NUMBER:	CXU-538						
NAME OF SUBMITTER:	Harry E. Moose						
Total Attachments: 3 source=CXU-538_Assignment_090408#page1.tif source=CXU-538_Assignment_090408#page2.tif source=CXU-538_Assignment_090408#page3.tif							

OP \$40.00 12179047

ATTORNEY DOCKET NO: CXU-538 (07-036)**JOINT INVENTION ASSIGNMENT OF WORLDWIDE RIGHTS**

WHEREAS, we, Pingshan Wang, a citizen of China, residing at 210 Wesley Street, Clemson, South Carolina 29631, and Chunrong Song, a citizen of China, residing at 809-3 Creekside Drive, Clemson, South Carolina 29631, as assignors, have made an invention entitled **HIGH-FREQUENCY STRUCTURES FOR NANOELECTRONICS AND MOLECULAR ELECTRONICS** as described and set forth in an application for Letters Patent of the United States of America, as filed July 24, 2008, and assigned USSN 12/179,047; and

WHEREAS, CLEMSON UNIVERSITY, a body politic and corporate under the laws of the State of South Carolina, whose Post Office Address is Clemson University, 91 Technology Drive, Room 222, Anderson, South Carolina, 29625; as assignee, is desirous of securing the entire right, title and interest in and to this invention in all countries throughout the world, and in and to the application for United States Letters Patent on this invention and the Letters Patent to be issued upon this application;

NOW, THEREFORE, be it known that for and in consideration of the sum of One Dollar (\$1.00) in hand paid and other good and valuable consideration the receipt of which from assignee is hereby acknowledged, we, as assignors, have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto the assignee, its lawful successors and assigns, our entire right, title, and interest in and to this invention and this application, and all divisions, and continuations thereof, and all Letters Patent of the United States which may be granted thereon, and all reissues thereof, and all rights to claim priority on the basis of such applications, and all applications for Letters Patent which may hereafter be filed for this

invention in any foreign country and all Letters Patent which may be granted on this invention in any foreign country, and all extensions, renewals, and reissues thereof, and we hereby authorize and request the Commissioner for Patents of the United States and any official of any foreign country whose duty it is to issue patents on applications as described above, to issue all Letters Patent for this invention to assignee, its successors and assigns, in accordance with the terms of this Agreement.

AND, WE HEREBY covenant that we have the full right to convey the interest assigned by this Assignment, and we have not executed, and will not execute any agreement in conflict with this Assignment;

AND, WE HEREBY further covenant and agree that we will, without further consideration, communicate with assignee, its successors and assigns, any facts known to us respecting this invention, and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver any and all papers that may be necessary or desirable to perfect the title of this invention in said assignee, its successors and assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States and any foreign country, it being understood that any expense incident to the execution of such papers shall be borne by the assignee, its successors and assigns.

IN TESTIMONY WHEREOF, we have hereunto set our hands.

Wang Pingshan

Signature of First Inventor

Pingshan Wang

Date: 09/03/08

Chunrong Song

Signature of Second Inventor

Chunrong Song

Date: 09/03/08